Silicon Diffused Power Transistor BUJ302AX

GENERAL DESCRIPTION

High-voltage, high-speed planar-passivated npn power switching transistor in a plastic full-pack envelope intended for use in high frequency electronic lighting ballast applications, converters, inverters, switching regulators, motor control systems, etc.

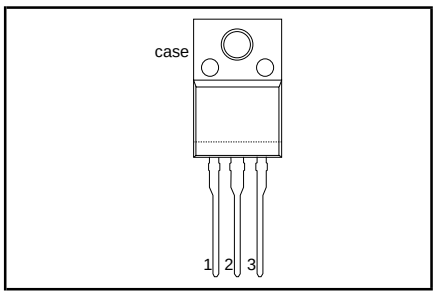
QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V_{CESM}	Collector-emitter voltage peak value	V_{BE} = 0 V	-	1000	V
V_{CBO}	Collector-Base voltage (open emitter)		-	1000	V
V_{CEO}	Collector-emitter voltage (open base)		-	500	V
I_C	Collector current (DC)		-	2	A
I_{CM}	Collector current peak value		-	3	A
P_{tot}	Total power dissipation	$T_{mb} \leq 25$ ˚C	-	18	W
V_{CEsat}	Collector-emitter saturation voltage	I_C = 1.0 A;I_B = 0.2 A	-	1.0	V
t_f	Fall time	Ic=1A,I_{B1}=0.2A	145	160	ns

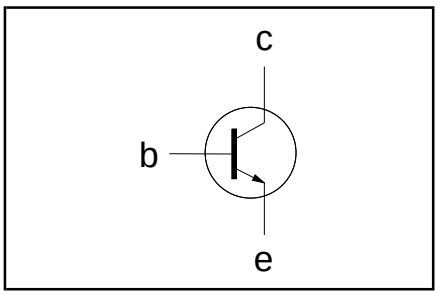
PINNING - SOT186A

PIN	DESCRIPTION
1	base
2	collector
3	emitter
case	isolated

PIN CONFIGURATION



SYMBOL



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum Rating System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CESM}	Collector to emitter voltage	V_{BE} = 0 V	-	1000	V
V_{CEO}	Collector to emitter voltage (open base)		-	500	V
V_{CBO}	Collector to base voltage (open emitter)		-	1000	V
I_C	Collector current (DC)		-	2	A
I_{CM}	Collector current peak value		-	3	A
I_B	Base current (DC)		-	0.75	A
I_{BM}	Base current peak value		-	1	A
P_{tot}	Total power dissipation	$T_{mb} \leq 25$ ˚C	-	18	W
T_{stg}	Storage temperature		-65	150	˚C
T_j	Junction temperature		-	150	˚C

THERMAL RESISTANCES

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SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
$R_{th\ j\text{-}mb}$	Junction to mounting base		-	7.2	K/W
$R_{th\ j\text{-}a}$	Junction to ambient	in free air	55	-	K/W

ISOLATION LIMITING VALUE & CHARACTERISTIC

T_{hs} = 25 ˚C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_{isol}	Repetitive peak voltage from all three terminals to external heatsink	R.H. ≤ 65% ; clean and dustfree	-		1500	V
C_{isol}	Capacitance from T2 to external heatsink	f = 1 MHz	-	12	-	pF

STATIC CHARACTERISTICS

T_{mb} = 25 ˚C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_{CES}	Collector cut-off current [1]	V_{BE} = 0 V; V_{CE} = $V_{CESMmax}$	-	-	0.2	mA
I_{CES}		V_{BE} = 0 V; V_{CE} = $V_{CESMmax}$; T_j = 125 ˚C	-	-	1.5	mA
I_{EBO}	Emitter cut-off current	V_{EB} = 5 V; I_C = 0 A	-	-	1	mA
$V_{CEOsust}$	Collector-emitter sustaining voltage	I_B = 0 A; I_C = 100 mA; L = 25 mH	500	-	-	V
V_{CEsat}	Collector-emitter saturation voltage	I_C = 1 A; I_B = 0.2 A	-	-	1.0	V
V_{BEsat}	Base-emitter saturation voltage	I_C = 1 A; I_B = 0.2 A	-	-	1.1	V
h_{FE}	DC current gain	I_C = 10 mA; V_{CE} = 5 V	10	-	35	
		I_C = 100 mA; V_{CE} = 5 V	14	-	35	

DYNAMIC CHARACTERISTICS

T_{mb} = 25 ˚C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
	Switching times (resistive load)	I_{Con} = 1.0 A; I_{Bon} = -I_{Boff} = 0.2 A; R_L = 75 ohms; V_{BB2} = 4 V;			
t_{on}	Turn-on time		-	1.0	µs
t_s	Turn-off storage time		-	4.0	µs
t_f	Turn-off fall time		-	0.8	µs
	Switching times (inductive load)	I_{Con} = 1.0 A; I_{Bon} = 0.2 A; L_B = 1 µH; -V_{BB} = 5 V			
t_s	Turn-off storage time		-	1.4	µs
t_f	Turn-off fall time		145	160	ns
	Switching times (inductive load)	I_{Con} = 1.0 A; I_{Bon} = 0.2 A; L_B = 1 µH; -V_{BB} = 5 V; T_j = 100 ˚C			
t_s	Turn-off storage time		-	1.5	µs
t_f	Turn-off fall time		-	200	ns

1 Measured with half sine-wave voltage (curve tracer).

MECHANICAL DATA

Dimensions in mm

Net Mass: 2 g

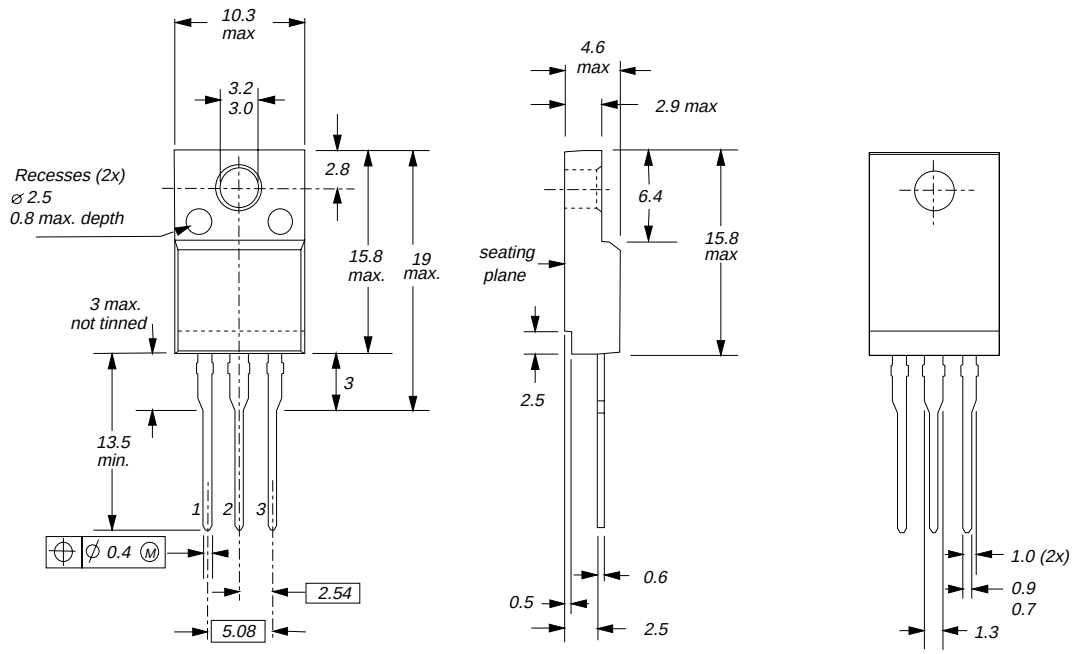


Fig.1. SOT186A; The seating plane is electrically isolated from all terminals.

Notes
1. Refer to mounting instructions for F-pack envelopes.
2. Epoxy meets UL94 V0 at 1/8".

DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	
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